

Description

The SIR462DP-T1-GE3 uses advanced trench technology

to provide excellent $R_{DS(ON)}$, low gate charge and

operation with gate voltages as low as 4.5V. This

device is suitable for use as a

Battery protection or in other Switching application.

General Features

V_{DS} = 30V I_D =50A

 $R_{DS(ON)} < 8.5 m\Omega V_{GS} = 10V$

Application

Battery protection

Load switch

Uninterruptible power supply

Package Marking and Ordering Information

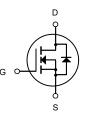
<u> </u>			
Product ID	Pack	Brand	Qty(PCS)
SIR462DP-T1-GE3	DFN5X6-8L	HXY MOSFET	5000

Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

Symbol	Parameter	Rating	Units
Vds	Drain-Source Voltage	30	V
VGS	Gate-Source Voltage	±20	V
l₀@Tc=25°C	Continuous Drain Current, V _{GS} @ 10V ¹	60	А
I⊳@Tc=100°C	Continuous Drain Current, V _{GS} @ 10V ¹	38	А
Ідм	Pulsed Drain Current ²	200	А
EAS	Single Pulse Avalanche Energy ³	36	mJ
las	Avalanche Current	50	А
P₀@Tc=25°C	Total Power Dissipation ⁴	ower Dissipation ⁴ 31	
Тѕтс	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
Reja	Thermal Resistance Junction-Ambient ¹	62	°C/W
Rejc	Thermal Resistance Junction-Case ¹	27	°C/W







N-Channel MOSFET

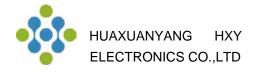


SIR462DP-T1-GE3

N-Channel Enhancement Mode MOSFET

Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units	
BV _{DSS}	Drain-Sourtce Breakdown Voltage	V _{GS} =0V,I _D =250 μ A	30			v	
I _{DSS}	Zero Gate Voltage Drain Current	V _{GS} =0V, V _{DS} =24V			1	μA	
I _{GSS}	Gate-Source Leakage Current	V_{GS} =±20V, V_{DS} =0A			±100	nA	
V _{GS(th)}	GATE-Source Threshold Voltage	V_{GS} = V_{DS} , I_D =250 μ A	1.2	1.5	2.5	v	
	2	V _{GS} =10V,I _D =30A		6.5	8.5		
R _{DS(ON)}	Drain-Source On Resistance ²	V _{GS} =4.5V,I _D =15A		11	14	mΩ	
G _{FS}	Forward Transconductance	V _{DS} =5V, I _D =30A		38		S	
C _{iss}	Input Capacitance			1317	1844	рF	
C _{oss}	Output Capacitance	V _{DS} =15V, V _{GS} =0V, f=1MHz		163	228		
C _{rss}	Reverse Transfer Capacitance			131	183		
t _{d(on)}	Turn-On Delay Time			4.6	9.2	ns	
tr	RiseTime	V_{DD} =15V,I _D =15A,R _L = Ω		12.2	22	ns	
t _{d(off)}	Turn-Off Delay Time	V _{GS} =15V,R _G =3.3Ω		26.6	53	ns	
t _f	Fall Time			8	16	ns	
Qg	Total Gate Charge			21	17.6	nC	
Q_{gs}	Gate-Source Charge	V _{GS} =4.5V, V _{DS} =15V,		2.35	5.9	nC	
\mathbf{Q}_{gd}	Gate-Drain "Miller" Charge	I _D =15A		5.9	7.1	nC	
V _{SD}	Source-Drain Diode Forward Voltage ²	ward Voltage ² V _{GS} =0V,I _S =1A			1	v	
IS	Continuous Source Current1.5	VG=VD=0V , Force			58	А	
ISM	Pulsed Source Current 2.5	Current			115	А	
trr	Reverse Recovery Time	IF=30A,		9.2			
Qrr	Reverse Recovery Charge	dI/dt=100A/¦ÌsTJ=25℃		2			



SIR462DP-T1-GE3 N-Channel Enhancement Mode MOSFET

Typical Characteristics

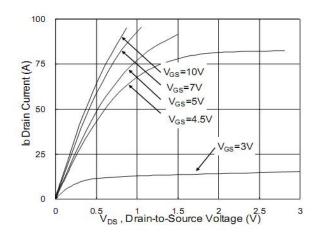


Fig.1 Typical Output Characteristics

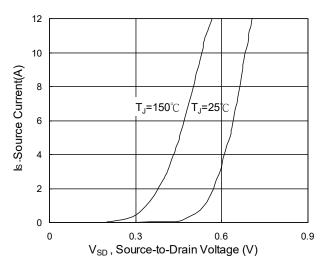


Fig.3 Forward Characteristics of reverse

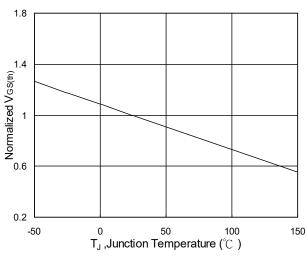


Fig.5 Normalized V_{GS(th)} vs. T_J

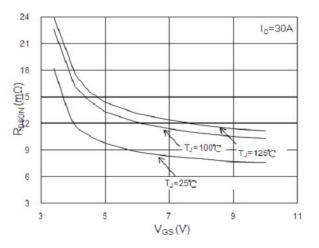


Fig.2 On-Resistance vs. Gate-Source

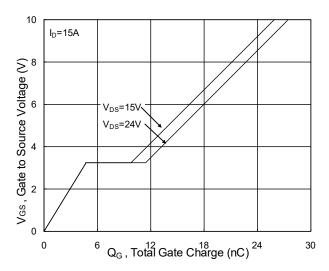
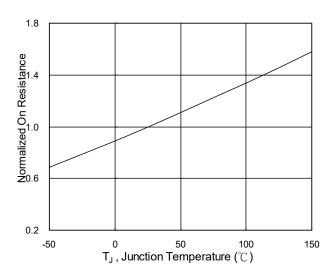
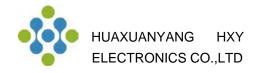


Fig.4 Gate-Charge Characteristics







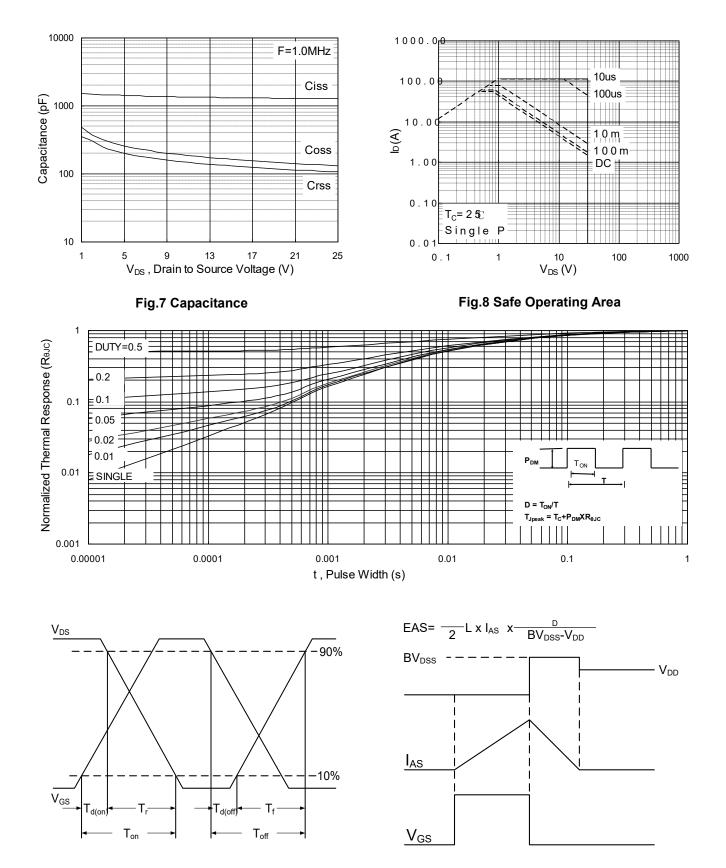
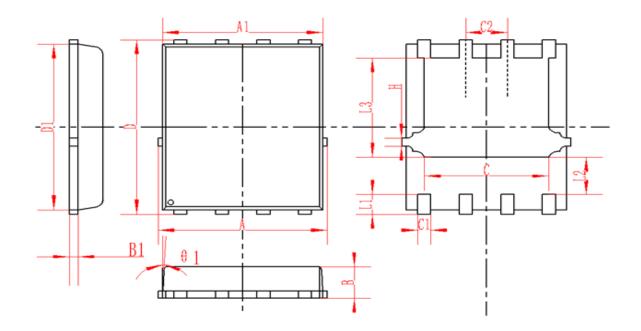


Fig.10 Switching Time Waveform



DFN5X6-8L Package Information



SYMBOL	MM			INCH		
STINDOL	MIN	NOM	MAX	MIN	NOM	MAX
А	5.3	5.5	5.7	0.208	0.216	0.224
A1	5.1	5.2	5.3	0.2	0.204	0.209
D	5.98	6	6.02	0.235	0.236	0.237
D1	5.85	6.05	6.25	0.23	0.238	0.246
В	0.85	0.95	1.05	0.033	0.037	0.041
B1	0.254REF		0.010REF			
С	3.95	4	4.05	0.156	0.157	0.159
C1	0.35	0.4	0.45	0.014	0.016	0.018
C2	1.27TYP			0.5TYP		
θ1	8°	10°	12°	8°	10°	12°
L1	0.63	0.64	0.65	0.025	0.025	0.026
L2	1.2	1.3	1.4	0.047	0.051	0.055
L3	3.415	3.42	3.425	0.134	0.135	0.135
Н	0.24	0.25	0.26	0.009	0.010	0.010



Attention

Any and all HUA XUAN YANG ELECTRONICS products described or contained herein do not have specifications that can handle applications that require extremely high levels of reliability, such as life-support systems, aircraft's control systems, or other applications whose failure can be reasonably expected to result in serious physical and/or material damage. Consult with your HUA XUAN YANG ELECTRONICS representative nearest you before using any HUA XUAN YANG ELECTRONICS products described or contained herein in such applications.

• HUA XUAN YANG ELECTRONICS assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all HUA XUAN YANG ELECTRONICS products described or contained herein.

• Specifications of any and all HUA XUAN YANG ELECTRONICS products described or contained herein stipulate the performance, characteristics, and functions of the described products in the independent state, and are not guarantees of the performance, characteristics, and functions of the described products as mounted in the customer's products or equipment. To verify symptoms and states that cannot be evaluated in an independent device, the customer should always evaluate and test devices mounted in the customer's products or equipment.

■ HUA XUAN YANG ELECTRONICS CO.,LTD. strives to supply high-quality high-reliability products. However, any and all semiconductor products fail with some probability. It is possible that these probabilistic failures could

give rise to accidents or events that could endanger human lives, that could give rise to smoke or fire, or that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents or events cannot occur. Such measures include but are not limited to protective circuits and error prevention circuits for safe design, redundant design, and structural design.

• In the event that any or all HUA XUAN YANG ELECTRONICS products (including technical data, services) described or contained herein are controlled under any of applicable local export control laws and regulations, such products must not be exported without obtaining the export license from the authorities concerned in accordance with the above law.

• No part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, including photocopying and recording, or any information storage or retrieval system, or otherwise, without the prior written permission of HUA XUAN YANG ELECTRONICS CO.,LTD.

Information (including circuit diagrams and circuit parameters) herein is for example only ; it is not guaranteed for volume production.
HUA XUAN YANG ELECTRONICS believes information herein is accurate and reliable, but no guarantees are made or implied regarding its use or any infringements of intellectual property rights or other rights of third parties.

Any and all information described or contained herein are subject to change without notice due to product/technology improvement, etc. When designing equipment, refer to the "Delivery Specification" for the HUA XUAN YANG ELECTRONICS product that you intend to use.